ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18
Stylesheet Version v18.0

Title of Invention

BOILING TEMPERATURE DESIGN IN PUMPED
MICROCHANNEL COOLING LOOPS

Application Number : 10/643638

Confirmation Number: 4432

First Named Applicant: Attorney Docket Number:

Art Unit:

Examiner:

Search string: (5316077 or 6167948 or 6606251 or 20030062149).pn

Pena Zhou

<u>Certification:</u> This Information Disclosure Statement was submitted under the following conditions, which satisfies the requirement under 37 CFR 1.97(e). The filer certified:

That each item of information contained in the information disclosure statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of the information disclosure statement.

US Patent Documents

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
	1	5316077	1994-05-31	Reichard			
	2	6167948	2001-01-02	Thomas	B1		
	3	6606251	2003-08-12	Kenny, Jr. et al.	B1		

US Published Applications

Note: Applicant is not required to submit a paper copy of cited US Published Applications

init	Cite.No.	Pub. No.	Date	Applicant	Kind	Class	Subclass
	1	20030062149	2003-04-03	Goodson et al.	A1		

Signature

Examiner Name	Date